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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	26
Number of Logic Elements/Cells	208
Total RAM Bits	-
Number of I/O	78
Number of Gates	2500
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=epf8282avtc100-4">https://www.e-xfl.com/pro/item?MUrl=&amp;PartUrl=epf8282avtc100-4</a>

## ...and More Features

- Peripheral register for fast setup and clock-to-output delay
- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see [Table 2](#))
- Software design support and automatic place-and-route provided by the Altera® MAX+PLUS® II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
- Additional design entry and simulation support provided by EDIF 2.0.0 and 3.0.0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

*Note:*

- (1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad

FLEX 8000 devices provide a large number of storage elements for applications such as digital signal processing (DSP), wide-data-path manipulation, and data transformation. These devices are an excellent choice for bus interfaces, TTL integration, coprocessor functions, and high-speed controllers. The high-pin-count packages can integrate multiple 32-bit buses into a single device. [Table 3](#) shows FLEX 8000 performance and LE requirements for typical applications.

**Table 3. FLEX 8000 Performance**

Application	LEs Used	Speed Grade			Units
		A-2	A-3	A-4	
16-bit loadable counter	16	125	95	83	MHz
16-bit up/down counter	16	125	95	83	MHz
24-bit accumulator	24	87	67	58	MHz
16-bit address decode	4	4.2	4.9	6.3	ns
16-to-1 multiplexer	10	6.6	7.9	9.5	ns

All FLEX 8000 device packages provide four dedicated inputs for synchronous control signals with large fan-outs. Each I/O pin has an associated register on the periphery of the device. As outputs, these registers provide fast clock-to-output times; as inputs, they offer quick setup times.

The logic and interconnections in the FLEX 8000 architecture are configured with CMOS SRAM elements. FLEX 8000 devices are configured at system power-up with data stored in an industry-standard parallel EPROM or an Altera serial configuration devices, or with data provided by a system controller. Altera offers the EPC1, EPC1213, EPC1064, and EPC1441 configuration devices, which configure FLEX 8000 devices via a serial data stream. Configuration data can also be stored in an industry-standard 32 K × 8 bit or larger configuration device, or downloaded from system RAM. After a FLEX 8000 device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Because reconfiguration requires less than 100 ms, real-time changes can be made during system operation. For information on how to configure FLEX 8000 devices, go to the following documents:

- [Configuration Devices for APEX & FLEX Devices Data Sheet](#)
- [BitBlaster Serial Download Cable Data Sheet](#)
- [ByteBlasterMV Parallel Port Download Cable Data Sheet](#)
- [Application Note 33 \(Configuring FLEX 8000 Devices\)](#)
- [Application Note 38 \(Configuring Multiple FLEX 8000 Devices\)](#)

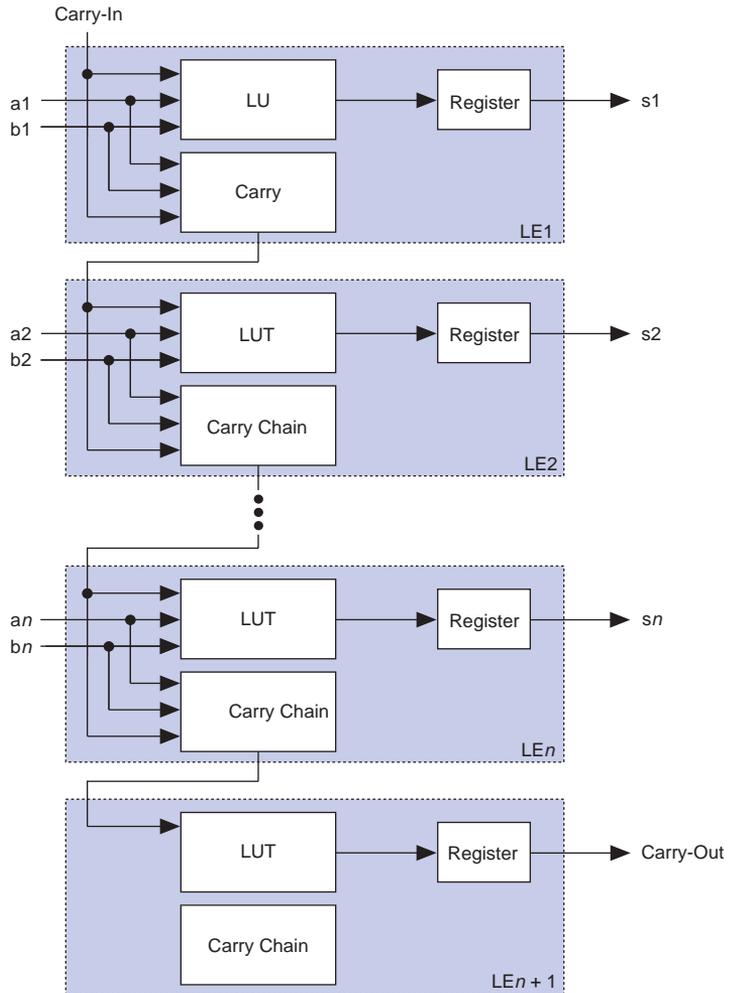
The FLEX 8000 architecture provides two dedicated high-speed data paths—carry chains and cascade chains—that connect adjacent LEs without using local interconnect paths. The carry chain supports high-speed counters and adders; the cascade chain implements wide-input functions with minimum delay. Carry and cascade chains connect all LEs in an LAB and all LABs in the same row. Heavy use of carry and cascade chains can reduce routing flexibility. Therefore, the use of carry and cascade chains should be limited to speed-critical portions of a design.

### *Carry Chain*

The carry chain provides a very fast (less than 1 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit moves forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the FLEX 8000 architecture to implement high-speed counters and adders of arbitrary width. The MAX+PLUS II Compiler can create carry chains automatically during design processing; designers can also insert carry chain logic manually during design entry.

**Figure 4** shows how an  $n$ -bit full adder can be implemented in  $n + 1$  LEs with the carry chain. One portion of the LUT generates the sum of two bits using the input signals and the carry-in signal; the sum is routed to the output of the LE. The register is typically bypassed for simple adders, but can be used for an accumulator function. Another portion of the LUT and the carry chain logic generate the carry-out signal, which is routed directly to the carry-in signal of the next-higher-order bit. The final carry-out signal is routed to another LE, where it can be used as a general-purpose signal. In addition to mathematical functions, carry chain logic supports very fast counters and comparators.

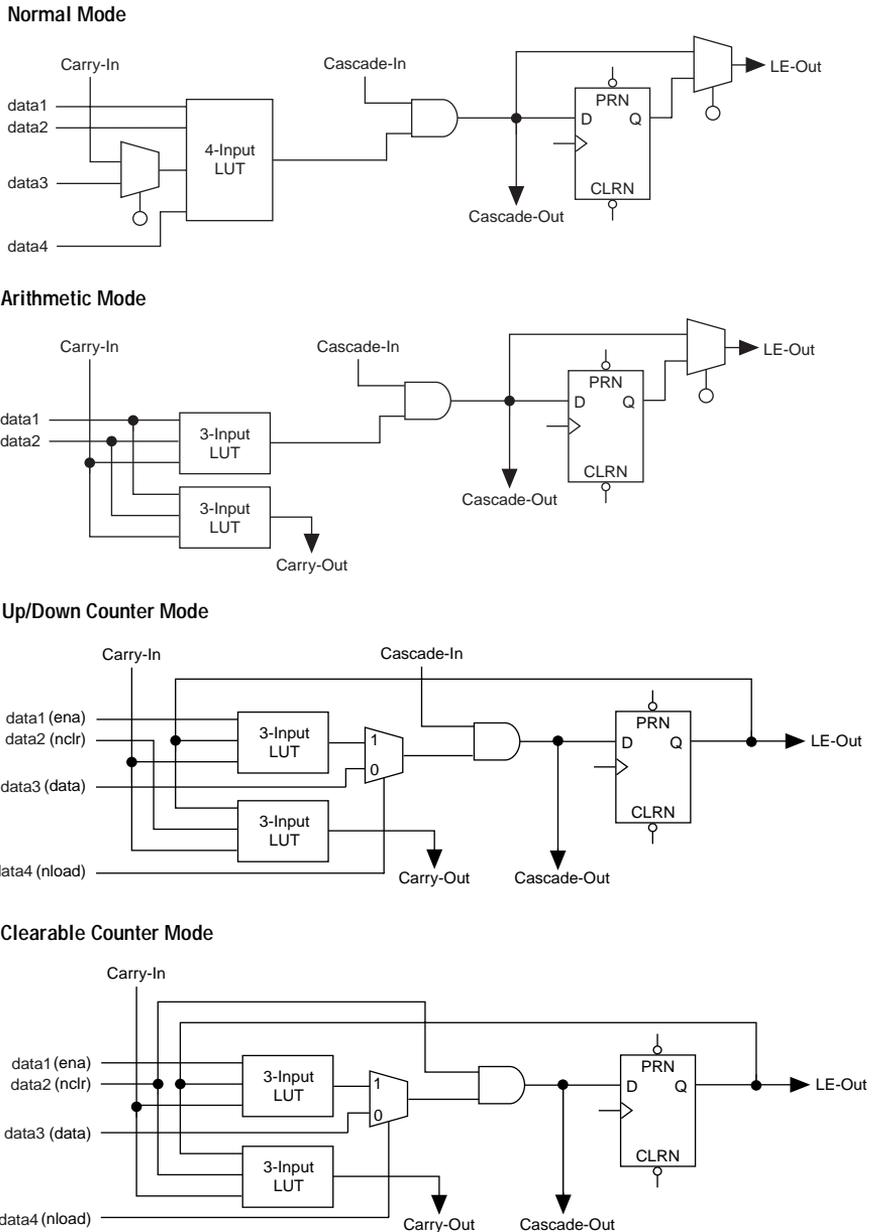
**Figure 4. FLEX 8000 Carry Chain Operation**



**Cascade Chain**

With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

Figure 6. FLEX 8000 LE Operating Modes



### *Internal Tri-State Emulation*

Internal tri-state emulation provides internal tri-stating without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable signals select the signal that drives the bus. However, if multiple output enable signals are active, contending signals can be driven onto the bus. Conversely, if no output enable signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The MAX+PLUS II software automatically implements tri-state bus functionality with a multiplexer.

### *Clear & Preset Logic Control*

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE is used to asynchronously load signals into a register. The register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

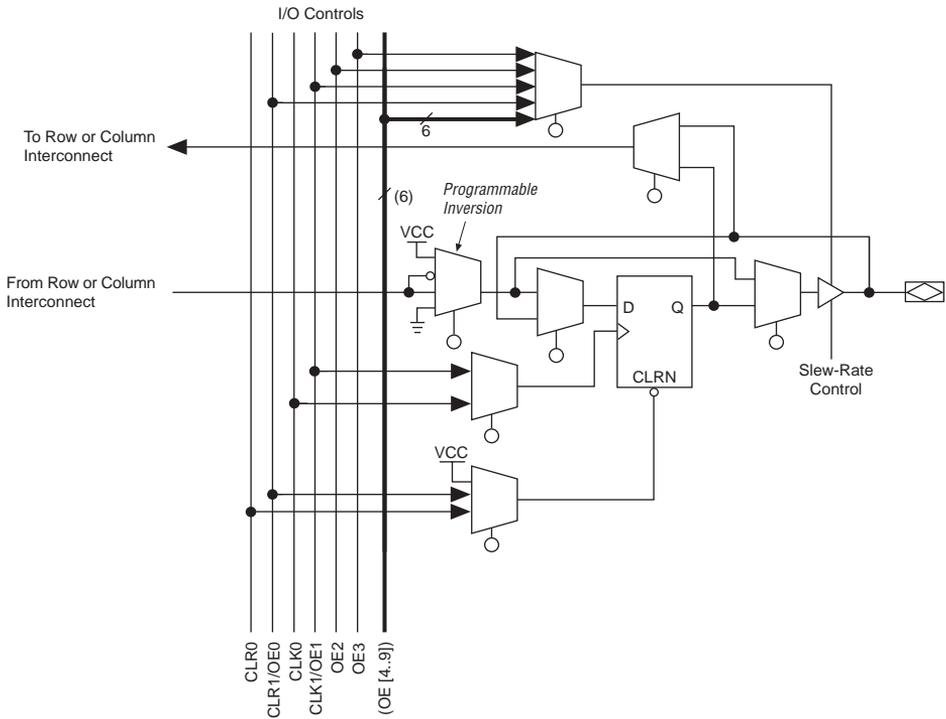
During compilation, the MAX+PLUS II Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six asynchronous modes, which are chosen during design entry. LPM functions that use registers will automatically use the correct asynchronous mode. See [Figure 7](#).

- Clear only
- Preset only
- Clear and preset
- Load with clear
- Load with preset
- Load without clear or preset

Figure 10. FLEX 8000 IOE

Numbers in parentheses are for EPF81500A devices only.



### Row-to-IOE Connections

Figure 11 illustrates the connection between row interconnect channels and IOEs. An input signal from an IOE can drive two separate row channels. When an IOE is used as an output, the signal is driven by an  $n$ -to-1 multiplexer that selects the row channels. The size of the multiplexer varies with the number of columns in a device. EPF81500A devices use a 27-to-1 multiplexer; EPF81188A, EPF8820A, EPF8636A, and EPF8452A devices use a 21-to-1 multiplexer; and EPF8282A and EPF8282AV devices use a 13-to-1 multiplexer. Eight IOEs are connected to each side of the row channels.

**Table 10. FLEX 8000 5.0-V Device Recommended Operating Conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CCINT}$	Supply voltage for internal logic and input buffers	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
$V_{CCIO}$	Supply voltage for output buffers, 5.0-V operation	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V
$V_I$	Input voltage		-0.5	$V_{CCINT} + 0.5$	V
$V_O$	Output voltage		0	$V_{CCIO}$	V
$T_A$	Operating temperature	For commercial use	0	70	°C
		For industrial use	-40	85	°C
$t_R$	Input rise time			40	ns
$t_F$	Input fall time			40	ns

**Table 11. FLEX 8000 5.0-V Device DC Operating Conditions** Notes (5), (6)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{IH}$	High-level input voltage		2.0		$V_{CCINT} + 0.5$	V
$V_{IL}$	Low-level input voltage		-0.5		0.8	V
$V_{OH}$	5.0-V high-level TTL output voltage	$I_{OH} = -4$ mA DC (7) $V_{CCIO} = 4.75$ V	2.4			V
	3.3-V high-level TTL output voltage	$I_{OH} = -4$ mA DC (7) $V_{CCIO} = 3.00$ V	2.4			V
	3.3-V high-level CMOS output voltage	$I_{OH} = -0.1$ mA DC (7) $V_{CCIO} = 3.00$ V	$V_{CCIO} - 0.2$			V
$V_{OL}$	5.0-V low-level TTL output voltage	$I_{OL} = 12$ mA DC (7) $V_{CCIO} = 4.75$ V			0.45	V
	3.3-V low-level TTL output voltage	$I_{OL} = 12$ mA DC (7) $V_{CCIO} = 3.00$ V			0.45	V
	3.3-V low-level CMOS output voltage	$I_{OL} = 0.1$ mA DC (7) $V_{CCIO} = 3.00$ V			0.2	V
$I_I$	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	μA
$I_{OZ}$	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	μA
$I_{CC0}$	$V_{CC}$ supply current (standby)	$V_I =$ ground, no load		0.5	10	mA

**Table 23. EPF8282A Interconnect Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
$t_{LOCAL}$		0.5		0.6		0.8	ns
$t_{ROW}$		4.2		4.2		4.2	ns
$t_{COL}$		2.5		2.5		2.5	ns
$t_{DIN\_C}$		5.0		5.0		5.5	ns
$t_{DIN\_D}$		7.2		7.2		7.2	ns
$t_{DIN\_IO}$		5.0		5.0		5.5	ns

**Table 30. EPF8452A I/O Element Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		0.7		0.8		0.9	ns
$t_{IOC}$		1.7		1.8		1.9	ns
$t_{IOE}$		1.7		1.8		1.9	ns
$t_{IOCO}$		1.0		1.0		1.0	ns
$t_{IOCOMB}$		0.3		0.2		0.1	ns
$t_{IOSU}$	1.4		1.6		1.8		ns
$t_{IOH}$	0.0		0.0		0.0		ns
$t_{IOCLR}$		1.2		1.2		1.2	ns
$t_{IN}$		1.5		1.6		1.7	ns
$t_{OD1}$		1.1		1.4		1.7	ns
$t_{OD2}$		–		–		–	ns
$t_{OD3}$		4.6		4.9		5.2	ns
$t_{XZ}$		1.4		1.6		1.8	ns
$t_{ZX1}$		1.4		1.6		1.8	ns
$t_{ZX2}$		–		–		–	ns
$t_{ZX3}$		4.9		5.1		5.3	ns

**Table 31. EPF8452A Interconnect Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.4		0.4	ns
$t_{LABCARRY}$		0.3		0.4		0.4	ns
$t_{LOCAL}$		0.5		0.5		0.7	ns
$t_{ROW}$		5.0		5.0		5.0	ns
$t_{COL}$		3.0		3.0		3.0	ns
$t_{DIN\_C}$		5.0		5.0		5.5	ns
$t_{DIN\_D}$		7.0		7.0		7.5	ns
$t_{DIN\_IO}$		5.0		5.0		5.5	ns

**Table 32. EPF8452A LE Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		2.0		2.3		3.0	ns
$t_{CLUT}$		0.0		0.2		0.1	ns
$t_{RLUT}$		0.9		1.6		1.6	ns
$t_{GATE}$		0.0		0.0		0.0	ns
$t_{CASC}$		0.6		0.7		0.9	ns
$t_{CICO}$		0.4		0.5		0.6	ns
$t_{CGEN}$		0.4		0.9		0.8	ns
$t_{CGENR}$		0.9		1.4		1.5	ns
$t_C$		1.6		1.8		2.4	ns
$t_{CH}$	4.0		4.0		4.0		ns
$t_{CL}$	4.0		4.0		4.0		ns
$t_{CO}$		0.4		0.5		0.6	ns
$t_{COMB}$		0.4		0.5		0.6	ns
$t_{SU}$	0.8		1.0		1.1		ns
$t_H$	0.9		1.1		1.4		ns
$t_{PRE}$		0.6		0.7		0.8	ns
$t_{CLR}$		0.6		0.7		0.8	ns

**Table 33. EPF8452A External Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{DRR}$		16.0		20.0		25.0	ns
$t_{ODH}$	1.0		1.0		1.0		ns

**Table 34. EPF8636A I/O Element Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		0.7		0.8		0.9	ns
$t_{IOC}$		1.7		1.8		1.9	ns
$t_{IOE}$		1.7		1.8		1.9	ns
$t_{IOCO}$		1.0		1.0		1.0	ns
$t_{IOCOMB}$		0.3		0.2		0.1	ns
$t_{IOSU}$	1.4		1.6		1.8		ns
$t_{IOH}$	0.0		0.0		0.0		ns
$t_{IOCLR}$		1.2		1.2		1.2	ns
$t_{IN}$		1.5		1.6		1.7	ns
$t_{OD1}$		1.1		1.4		1.7	ns
$t_{OD2}$		1.6		1.9		2.2	ns
$t_{OD3}$		4.6		4.9		5.2	ns
$t_{XZ}$		1.4		1.6		1.8	ns
$t_{ZX1}$		1.4		1.6		1.8	ns
$t_{ZX2}$		1.9		2.1		2.3	ns
$t_{ZX3}$		4.9		5.1		5.3	ns

**Table 35. EPF8636A Interconnect Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.4		0.4	ns
$t_{LABCARRY}$		0.3		0.4		0.4	ns
$t_{LOCAL}$		0.5		0.5		0.7	ns
$t_{ROW}$		5.0		5.0		5.0	ns
$t_{COL}$		3.0		3.0		3.0	ns
$t_{DIN\_C}$		5.0		5.0		5.5	ns
$t_{DIN\_D}$		7.0		7.0		7.5	ns
$t_{DIN\_IO}$		5.0		5.0		5.5	ns

**Table 36. EPF8636A LE Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		2.0		2.3		3.0	ns
$t_{CLUT}$		0.0		0.2		0.1	ns
$t_{RLUT}$		0.9		1.6		1.6	ns
$t_{GATE}$		0.0		0.0		0.0	ns
$t_{CASC}$		0.6		0.7		0.9	ns
$t_{CICO}$		0.4		0.5		0.6	ns
$t_{CGEN}$		0.4		0.9		0.8	ns
$t_{CGENR}$		0.9		1.4		1.5	ns
$t_C$		1.6		1.8		2.4	ns
$t_{CH}$	4.0		4.0		4.0		ns
$t_{CL}$	4.0		4.0		4.0		ns
$t_{CO}$		0.4		0.5		0.6	ns
$t_{COMB}$		0.4		0.5		0.6	ns
$t_{SU}$	0.8		1.0		1.1		ns
$t_H$	0.9		1.1		1.4		ns
$t_{PRE}$		0.6		0.7		0.8	ns
$t_{CLR}$		0.6		0.7		0.8	ns

**Table 37. EPF8636A External Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{DDR}$		16.0		20.0		25.0	ns
$t_{ODH}$	1.0		1.0		1.0		ns

**Table 44. EPF81188A LE Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		2.0		2.5		3.2	ns
$t_{CLUT}$		0.0		0.0		0.0	ns
$t_{RLUT}$		0.9		1.1		1.5	ns
$t_{GATE}$		0.0		0.0		0.0	ns
$t_{CASC}$		0.6		0.7		0.9	ns
$t_{CICO}$		0.4		0.5		0.6	ns
$t_{CGEN}$		0.4		0.5		0.7	ns
$t_{CGENR}$		0.9		1.1		1.5	ns
$t_C$		1.6		2.0		2.5	ns
$t_{CH}$	4.0		4.0		4.0		ns
$t_{CL}$	4.0		4.0		4.0		ns
$t_{CO}$		0.4		0.5		0.6	ns
$t_{COMB}$		0.4		0.5		0.6	ns
$t_{SU}$	0.8		1.1		1.2		ns
$t_H$	0.9		1.1		1.5		ns
$t_{PRE}$		0.6		0.7		0.8	ns
$t_{CLR}$		0.6		0.7		0.8	ns

**Table 45. EPF81188A External Timing Parameters**

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{DRR}$		16.0		20.0		25.0	ns
$t_{ODH}$	1.0		1.0		1.0		ns

**Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 2 of 3)**

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
DATA7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	–	96	–	17
TDO (4)	27	27 (5)	18	–	18	–	102
TCK (4), (6)	72	44 (5)	72	–	88	–	27
TMS (4)	20	43 (5)	11	–	86	–	29
TRST (7)	52	52 (8)	50	–	71	–	45
Dedicated Inputs (10)	12, 31, 54, 73	12, 31, 54, 73	3, 23, 53, 73	3, 24, 53, 74	9, 26, 82, 99	C3, D14, N2, R15	14, 33, 94, 113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	–	–	–	–	16, 40, 60, 69, 91, 112, 122, 141	–	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

**Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 3 of 3)**

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
GND	5, 26, 47, 68	5, 26, 47, 68	2, 13, 30, 44, 52, 63, 80, 94	19, 44, 69, 94	7, 17, 27, 39, 54, 80, 81, 100,101, 128, 142	C12, D4, D7, D9, D13, G4, G13, H3, H12, J4, J13, L1, M3, M8, M12, M15, N4	12, 13, 34, 35, 51, 63, 75, 80, 83, 93, 103, 115, 126, 131, 143, 155
No Connect (N.C.)	—	—	—	2, 6, 13, 30, 37, 42, 43, 50, 52, 56, 63, 80, 87, 92, 93, 99	—	—	—
Total User I/O Pins (9)	64	64	74	64	108	116	116

**Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)**

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A (1)
nSP (2)	120	1	R15	207	207	5
MSEL0 (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	T3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	T8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

**Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 1 of 3)**

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
nSP (2)	A15	C14	237	237	W1	304
MSEL0 (2)	B14	G15	21	19	N1	26
MSEL1 (2)	R15	L15	40	38	H3	51
nSTATUS (2)	P2	L3	141	142	G19	178
nCONFIG (2)	R1	R4	117	120	B18	152
DCLK (2)	B2	C4	184	183	U18	230
CONF_DONE (2)	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDynBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	K3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

**Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 3 of 3)**

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
GND	B1, D4, E14, F7, F8, F9, F12, G6, G7, G8, G9, G10, H1, H4, H5, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K6, K7, K8, K9, K11, L15, N3, P1	A1, D6, E11, E7, E9, G4, G5, G13, G14, J5, J13, K4, K14, L5, L13, N4, N7, N9, N11, N14	8, 9, 30, 31, 52, 53, 72, 90, 108, 115, 129, 139, 151, 161, 173, 185, 187, 193, 211, 229	6, 7, 28, 29, 50, 51, 71, 85, 92, 101, 118, 119, 140, 141, 162, 163, 184, 185, 186, 198, 208, 214, 228	D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17	9, 11, 36, 38, 65, 67, 90, 108, 116, 128, 150, 151, 175, 177, 206, 208, 231, 232, 237, 253, 265, 273, 291
No Connect (N.C.)	–	–	61, 62, 119, 120, 181, 182, 239, 240	–	–	10, 21, 23, 25, 35, 37, 39, 40, 41, 42, 52, 55, 66, 68, 146, 147, 161, 173, 174, 176, 187, 188, 189, 190, 192, 194, 195, 205, 207, 219, 221, 233, 234, 235, 236, 302, 303
Total User I/O Pins (9)	148	180	180	177	204	204

### Notes to tables:

- (1) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#) for more information.
- (2) This pin is a dedicated pin and is not available as a user I/O pin.
- (3) SDO<sub>UT</sub> will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDO<sub>UT</sub> as a user I/O pin; the user can override the MAX+PLUS II software and use SDO<sub>UT</sub> as a user I/O pin.
- (4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
- (5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
- (6) If this pin is used as an input in user mode, ensure that it does not toggle before or during configuration.
- (7) TR<sub>ST</sub> is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
- (8) Pin 52 is a V<sub>CC</sub> pin on EPF8452A devices only.
- (9) The user I/O pin count includes dedicated input pins and all I/O pins.
- (10) Unused dedicated inputs should be tied to ground on the board.
- (11) SDO<sub>UT</sub> does not exist in the EPF8636GC192 device.
- (12) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
- (13) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
- (14) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TDI, TCK, TMS, and TR<sub>ST</sub> should be tied to GND.

## Revision History

The information contained in the *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 supersedes information published in previous versions. The *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 contains the following change: minor textual updates.